

**AMENDMENTS TO THE CLAIMS**

1. (Currently Amended) An arrangement comprising:

a first semiconductor chip configured to transmit load control data and pilot data;

~~and a second semiconductor chip connected~~ coupled to the first semiconductor chip and configured to receive the load control data and the pilot data; and thereto,

a plurality of electrical loads coupled to the second semiconductor chip;

wherein the second semiconductor chip is configured to:

a) ~~where the second semiconductor chip is additionally connected to electrical loads and drive the plurality of drives these electrical loads based on the basis of a timing that which is defined by the load control data, where the first semiconductor chip transmits to the second semiconductor chip the load control data and pilot data which control the second semiconductor chip, and~~

b) ~~transmit to the first semiconductor chip where the second semiconductor chip transmits to the first semiconductor chip diagnostic data, which represent at least one of a plurality of states of prevailing in the second semiconductor chip and events which occur in the second semiconductor chip, and~~

wherein

c) ~~control the first semiconductor chip includes means for transmitting appropriate pilot data to the second semiconductor chip, and the second semiconductor chip includes means for controlling a transmission rate of by which the diagnostic data is transmitted to the first semiconductor chip in accordance with as prescribed by the appropriate pilot data.~~

2. (Original) The arrangement as claimed in claim 1, wherein the first semiconductor chip is a program-controlled unit.

3. (Original) The arrangement as claimed in claim 1 wherein the second semiconductor chip is a power chip.

4. (Currently Amended) The arrangement as claimed in claim 1, wherein the diagnostic data are transmitted in time with a transmission clock signal generated in the second semiconductor chip, and the ~~and wherein this~~ transmission clock signal is not transmitted to the first semiconductor chip.

5. (Currently Amended) The arrangement as claimed in claim 1, wherein the transmission rate is prescribed by transmitting a division factor, and ~~wherein the~~ second semiconductor chip divides the frequency of a transmission clock signal received from ~~transmitted to it by~~ the first semiconductor chip by the division factor, and transmits the diagnostic data to the first semiconductor chip in time with the resultant transmission signal.

6. (Currently Amended) The arrangement as claimed in claim 5, wherein the transmission clock signal transmitted ~~supplied to~~ the second semiconductor chip represents the transmission clock which is used by the first semiconductor chip to transmit the load control data or the pilot data to the second semiconductor chip.

7. (Currently Amended) The arrangement as claimed in claim 6, wherein the diagnostic data are transmitted in units of frames and each, ~~where a~~ frame starts with a start bit having a prescribed value and ends with one or two stop bits having prescribed values.

8. (Currently Amended) The arrangement as claimed in claim 1, wherein the first semiconductor chip ascertains a ~~the~~ phase of the diagnostic data by oversampling the diagnostic data.

9. (Currently Amended) The arrangement as claimed in claim 1, wherein the diagnostic data are transmitted via a line, ~~via which~~ transmits neither the load control data nor the pilot data ~~are~~ transmitted.

10. (Currently Amended) The arrangement as claimed in claim 1, wherein the load control data and the pilot data are transmitted via a ~~second~~ transmission channel.

11. (Currently Amended) The arrangement as claimed in claim 10, wherein the ~~second~~ transmission channel comprises:

a transmission clock line via which the first semiconductor chip transmits a transmission clock signal to the second semiconductor chip;

a data line via which the first semiconductor chip transmits the load control data and the pilot data to the second semiconductor chip in time with the transmission clock signal; and

a chip select line via which the first semiconductor chip transmits a ~~the~~ chip select signal to the second semiconductor chip,

wherein said chip select signal indicates ~~signaling~~ to the second semiconductor chip a ~~the~~ start and end of the data transmission ~~of data~~ intended for the second semiconductor chip via the data line.

12. (Currently Amended) The arrangement as claimed in claim 1, wherein the load control data and the pilot data are transmitted in units of frames; and ~~wherein the load control data frames and the pilot data frames are transmitted using time-division multiplexing.~~

13. (Currently Amended) The arrangement as claimed in claim 12, wherein the first semiconductor

chip defines time windows of constant length and transmits in each time window either a load control data frame or a pilot control data frame or no data.

14. (Currently Amended) The arrangement as claimed in claim 13, wherein the first semiconductor chip transmits no further load control data frames ~~frame~~ for a respective length of n time windows after transmission of a load control data frame,

wherein ~~where~~  $n \geq 0$  and ~~where~~ n can be set by a ~~the~~ user of the arrangement.

15. (Currently Amended) The arrangement as claimed in claim 14, wherein a pilot data frame can be transmitted only in a time window in which no load control data frame is ~~to be~~ transmitted.

16. (Original) The arrangement as claimed in claim 13, wherein transmission of the pilot data has priority when load control data and pilot data are awaiting transmission simultaneously.

17. (Currently Amended) An ~~The~~ arrangement comprising ~~as claimed in claim 10,~~ wherein the  
a first semiconductor chip and a second semiconductor chip connected thereto,

where the second semiconductor chip is additionally connected to electrical loads and drives these electrical loads on the basis of a timing which is defined by load control data,

where the first semiconductor chip transmits via a transmission channel to the second semiconductor chip the load control data and pilot data which control the second semiconductor chip,

where the ~~second~~ transmission channel comprises:

a first transmission clock line via which the first semiconductor chip transmits a

transmission clock signal to the second semiconductor chip;

a second transmission clock line via which the first semiconductor chip transmits an the  
inverse of the transmission clock signal to the second semiconductor chip;

a first data line via which the first semiconductor chip transmits the load control data and the  
pilot data to the second semiconductor chip in time with the transmission clock  
signal;

a second data line via which the first semiconductor chip transmits an the inverse of the load  
control data and an the inverse of the pilot data to the second semiconductor chip;  
and

a chip select line via which the first semiconductor chip transmits a chip select signal to the  
second semiconductor chip,

wherein said chip select signal signals ~~signaling~~ to the second semiconductor chip a the start  
and end of ~~the~~ transmission of data intended for the second semiconductor chip via  
the data line;

where the second semiconductor chip transmits to the first semiconductor chip diagnostic data  
which represent at least one of states prevailing in the second semiconductor chip and events  
which occur in the second semiconductor chip,

wherein the first semiconductor chip includes means for transmitting appropriate pilot data to the  
second semiconductor chip, and the second semiconductor chip includes means for  
controlling a transmission rate by which the diagnostic data is transmitted to the first  
semiconductor chip in accordance with the appropriate pilot data.

18. (Currently Amended) The arrangement as claimed in claim 17, wherein the output drivers on the first semiconductor chip, which output the load control data, the pilot data and the transmission clock signal, are LVDS drivers or other special drivers whose use allows electromagnetic interference to be kept down.

19. (Currently Amended) The arrangement as claimed in claim 1, wherein the first semiconductor chip has a plurality of ~~respective different~~ output drivers configured to output ~~for outputting~~ the load control data, the pilot data and the transmission clock signal, ~~and wherein the first semiconductor chip can have prescribed to it which of the plurality of different output drivers needs to be used in each case.~~

20. (New) The arrangement as claimed in claim 17, wherein output drivers on the first semiconductor chip, which output the load control data, the pilot data and the transmission clock signal, are special drivers configured to minimize electromagnetic interference.